

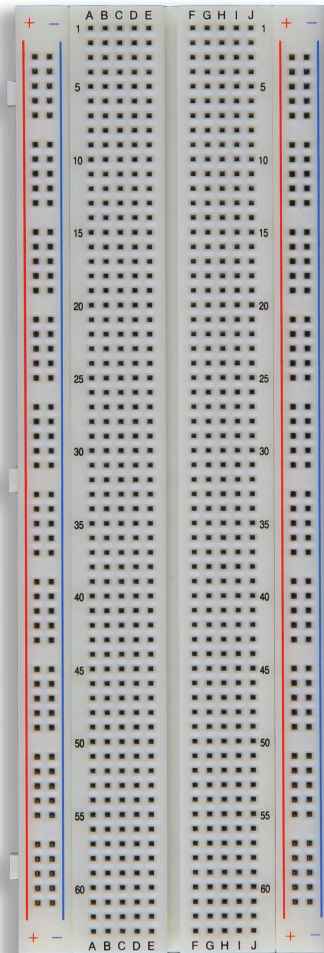
GS-830

830 TIE-POINT, SOLDERLESS BREADBOARD WITH BUS STRIP

Applications

The GS-830 is a modular type solderless breadboard that is comprised of the GS-100 bus strip and the GS-630 breadboard. It is a great way to prototype low frequency or DC powered circuits. It is ideal for:

- Educational labs
- Hobbyists



Features

- 830 Tie-points
- ABS plastic body
- Square hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 7 total 16-pin ICs
- Measures 6.5 x 2.125 x 0.33 in
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

GS-830

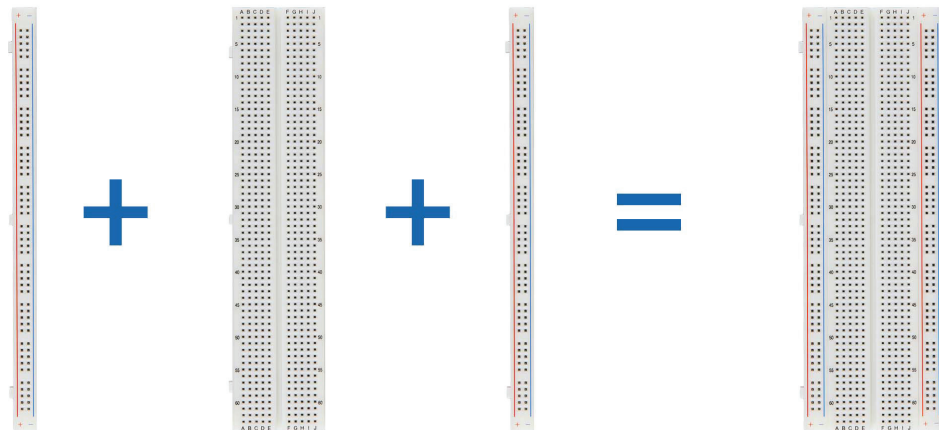
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GS-830 Components



GS-100*

GS-630

GS-100*

GS-830

*The GS-100 is sold as a pack of two